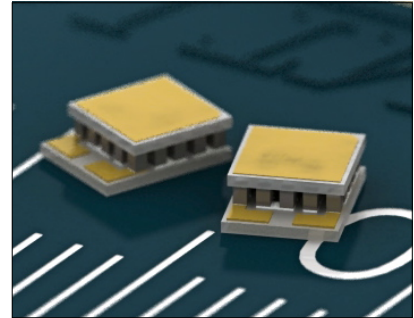


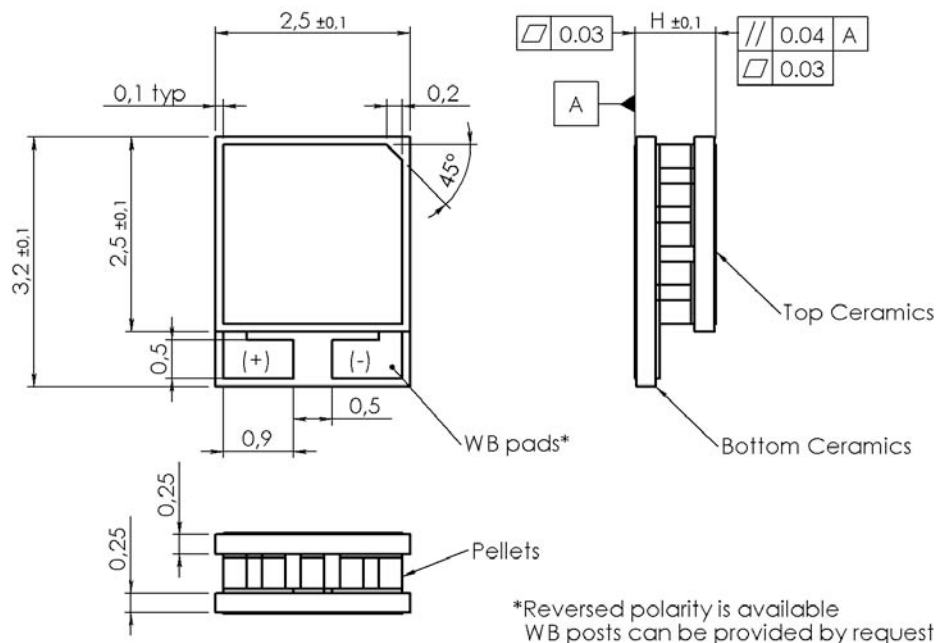
Performance Parameters 1MD03-012-XX

Type	ΔT_{max} K	Q_{max} W	I_{max} A	U_{max} V	AC R Ohm	H mm
1MD03-012-xx (N=12)						
1MD03-012-04	71	0.9	1.1	1.5	1.1	0.9
1MD03-012-05	72	0.8	0.9		1.3	1.1

Performance specified at 300K, vacuum



Technical Drawing



Options available

A. TEC Assembly:

Solder SnSb (T_{melt}=230°C)

B. Ceramics:

1. Pure Al₂O₃ (100%)
2. Alumina (Al₂O₃- 96%)
3. Aluminum Nitride (AlN)

100% Al₂O₃ used by default

C. Ceramics Surface Options

1. Blank ceramics
2. Metallized:
 - 2.1 Ni / Sn(Bi)
 - 2.2 Gold plating
3. Metallized and pre-tinned:
 - 3.1 Solder 94 (PbSnBi, T_{melt}=94°C)
 - 3.2 Solder 117 (In-Sn, T_{melt}=117°C)
 - 3.3 Solder 138 (Sn-Bi, T_{melt}=138°C)
 - 3.4 Solder 183 (Pb-Sn, T_{melt}=183°C)

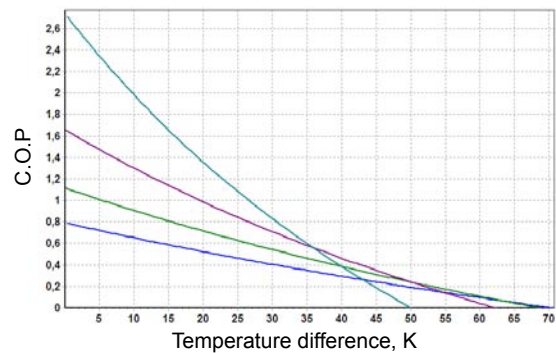
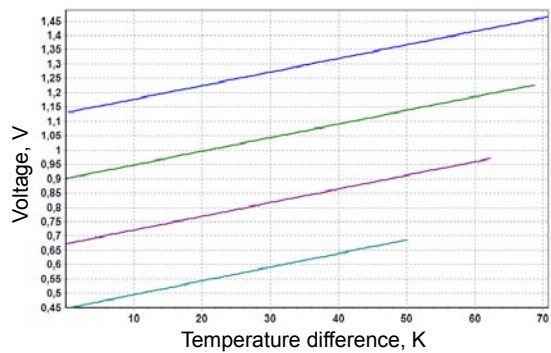
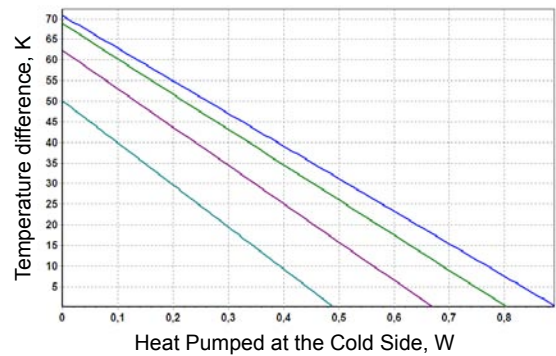
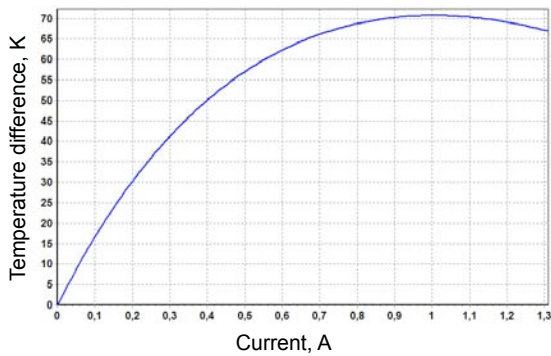
D. Thermistor (optional)

Can be mounted to cold side ceramics edge. Calibration is available.

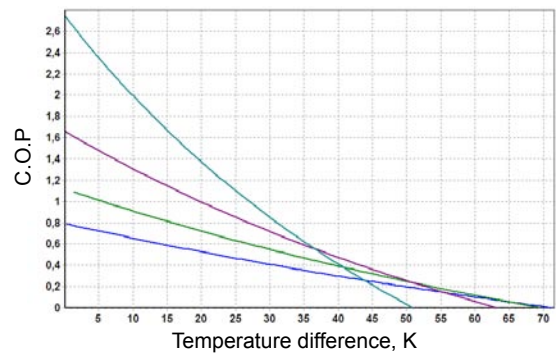
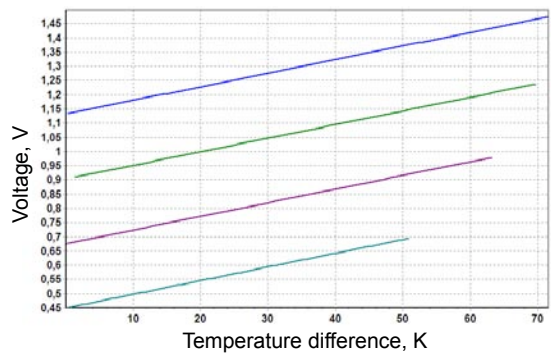
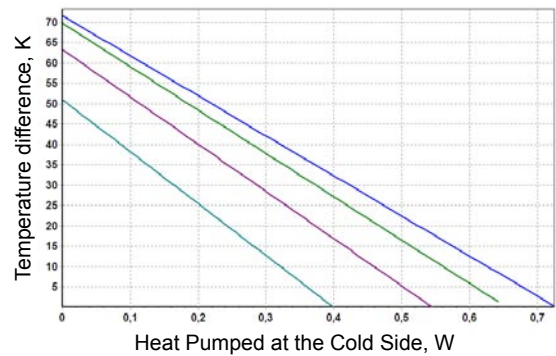
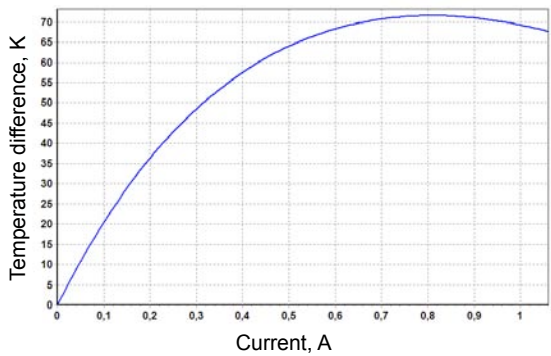
E. Terminal contacts

1. Au plated WB pads
2. Au plated WB posts
3. Pre-tinned Copper wires
4. Insulated Wires

Performance Plots 1MD03-012-04



Performance Plots 1MD03-012-05

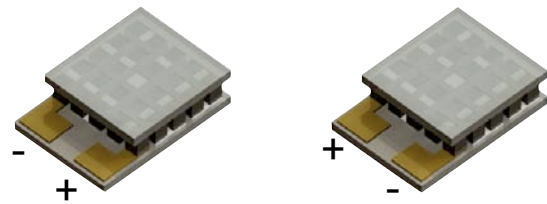


Color Legend: **I_{max}**, **0.8 I_{max}**, **0.6 I_{max}**, **0.4 I_{max}**

Additional Options

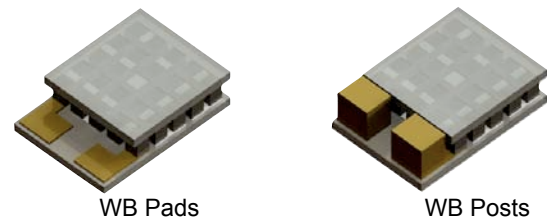
TEC Polarity

TEC Polarity can be changed for free by request. The specified in this datasheet polarity is typical. It can be reversed without charge in accordance to Customer application requirements.



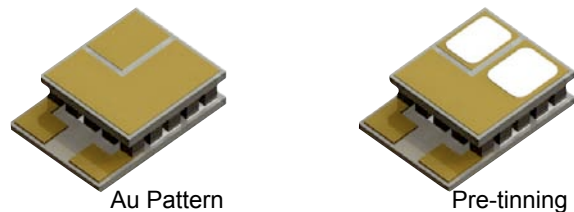
WB Posts or Pads

WB pads or WB posts solutions are available. WB pads (no posts) are provided as standard. WB Posts solution is provided in accordance to Customer's demands and depending of TEC height.



Customized Au Patterns

Customized Au patterns solution on TEC cold side ceramics is available. Selective Pre-tinning solution is available. Please, contact us for additional information about customized Au patterns requirements.



Application Tips

1. Never heat TE module more than 200°C (TEC assembled at 230°C).
2. Never use TE module without attached heat sink at hot (bottom) side.
3. Connect TE module to DC power supply according to polarity.
4. Do not apply DC current higher than I_{max}.

Installation

1. Mechanical Mounting. TEC is placed between two heat exchangers . This construction is fixed by screws or in another mechanical way. It is suitable for large modules (with dimensions 30x30mm and larger). Miniature types require other assembling methods in most cases.
2. Soldering. This method is suitable for a TE module with metallized outside surfaces. RMT provides this option and also makes pre-tinning for TE modules.
3. Glueing. It is an up-to-date method that is used by many customers due to availability of glues with good thermoconductive properties. A glue is usually based on some epoxy compound filled with some thermoconductive material such as graphite or diamond powders, silver, SiN and others. The application of a specific type depends on application features and the type of a TE module.

